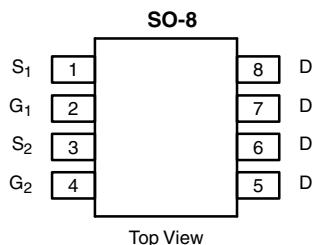


Complementary (N- and P-Channel) MOSFET

PRODUCT SUMMARY				
	V _{DS} (V)	R _{D(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
N-Channel	30	0.017 at V _{GS} = 10 V	12	7.9
		0.020 at V _{GS} = 4.5 V	11	
P-Channel	- 8	0.027 at V _{GS} = - 4.5 V	- 8	16.5
		0.037 at V _{GS} = - 2.5 V	- 6.8	

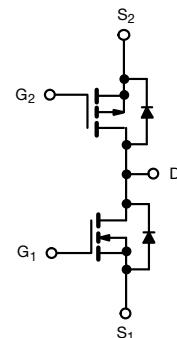
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Level Shift
- Load Switch



Ordering Information: Si4501BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V _{DS}	30	- 8	V
Gate-Source Voltage	V _{GS}	± 20	± 8	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	12	- 8	
	T _C = 70 °C	9.5	- 6.4	
	T _A = 25 °C	9 ^{b, c}	- 6.4 ^{b, c}	
	T _A = 70 °C	7.2 ^{b, c}	- 5.1 ^{b, c}	
Pulsed Drain Current (10 µs Pulse Width)	I _{DM}	40	- 40	A
Source-Drain Current Diode Current	T _C = 25 °C	4.0	- 2.8	
	T _A = 25 °C	2.2 ^{b, c}	- 1.8 ^{b, c}	
Pulsed Source-Drain Current	I _{SM}	40	- 40	
Single Pulse Avalanche Current	I _{AS}	5	- 5	
Single Pulse Avalanche Energy	E _{AS}	1.25	1.25	mJ
Maximum Power Dissipation	T _C = 25 °C	4.5	3.1	
	T _C = 70 °C	2.8	2.0	
	T _A = 25 °C	2.5 ^{b, c}	2 ^{b, c}	
	T _A = 70 °C	1.6 ^{b, c}	1.28 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	40	50	52	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	22	28	32	40

Notes:

- Based on T_C = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under steady state conditions is 95 °C/W (N-Channel) and 110 °C/W (P-Channel).

SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	N-Ch	30		V		
		$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	P-Ch	- 8				
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch		34	mV/ $^\circ\text{C}$		
		$I_D = -250 \mu\text{A}$	P-Ch		- 3			
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch		- 4.5			
		$I_D = -250 \mu\text{A}$	P-Ch		2.6			
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	N-Ch	0.8	2	V		
		$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	P-Ch	- 0.45	- 0.9			
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch		± 100	nA		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	P-Ch		± 100			
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1	μA		
		$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch		- 1			
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	N-Ch		5			
		$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	P-Ch		- 5			
On-State Drain Current ^b	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20		A		
		$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 20				
Drain-Source On-State Resistance ^b	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	N-Ch	0.0135	0.017	Ω		
		$V_{GS} = -4.5 \text{ V}, I_D = -6 \text{ A}$	P-Ch	0.021	0.027			
		$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	N-Ch	0.016	0.020			
		$V_{GS} = -2.5 \text{ V}, I_D = -5 \text{ A}$	P-Ch	0.029	0.037			
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 10 \text{ A}$	N-Ch		29	S		
		$V_{DS} = -15 \text{ V}, I_D = -6 \text{ A}$	P-Ch		24			
Dynamic^a								
Input Capacitance	C_{iss}	N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		805	pF		
Output Capacitance	C_{oss}		P-Ch		1400			
Reverse Transfer Capacitance	C_{rss}		N-Ch		170			
Total Gate Charge	Q_g		P-Ch		660			
Gate-Source Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	N-Ch		80	nC		
		$V_{DS} = -4 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -6 \text{ A}$	P-Ch		630			
Gate-Drain Charge	Q_{gd}	N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	N-Ch		16.5	Ω		
			P-Ch		25			
Gate Resistance	R_g	$f = 1 \text{ MHz}$		N-Ch	0.3	1.1	2.2	Ω
				P-Ch	0.9	4.2	8.4	

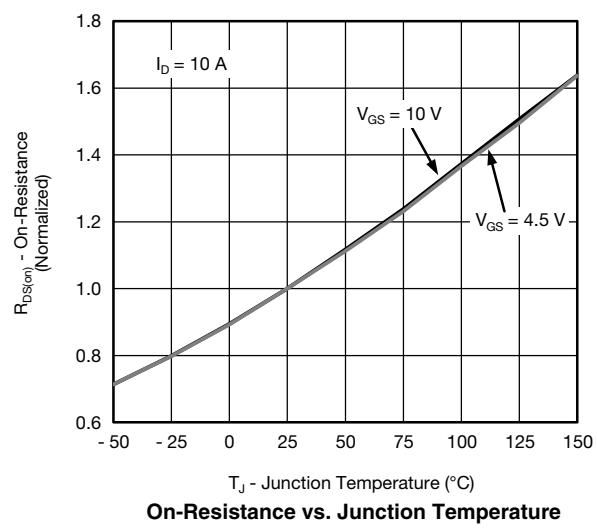
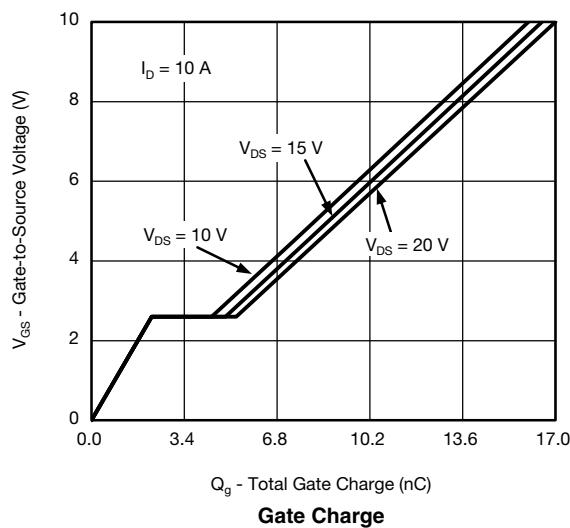
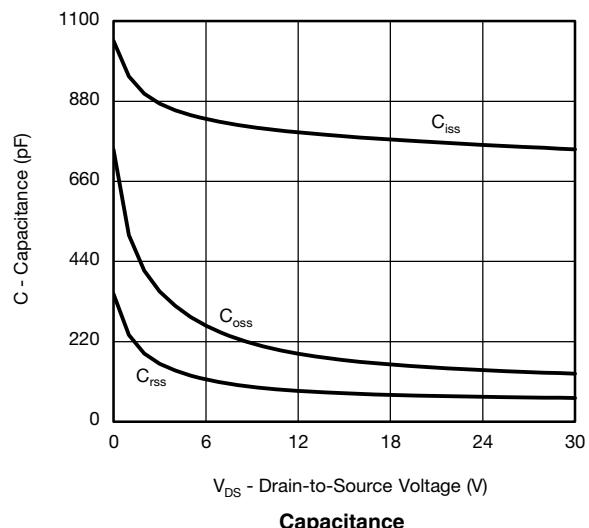
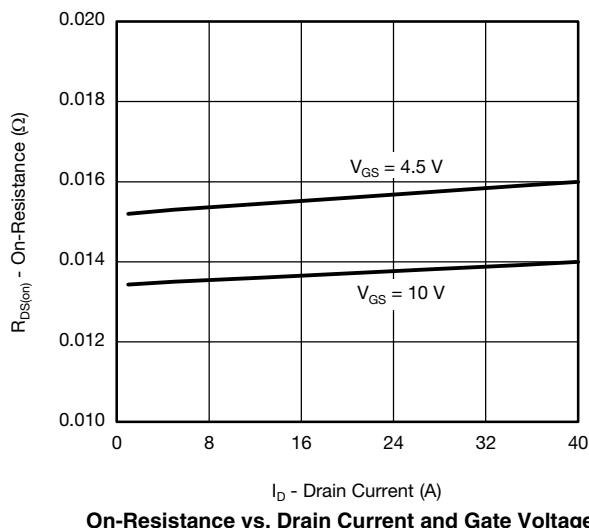
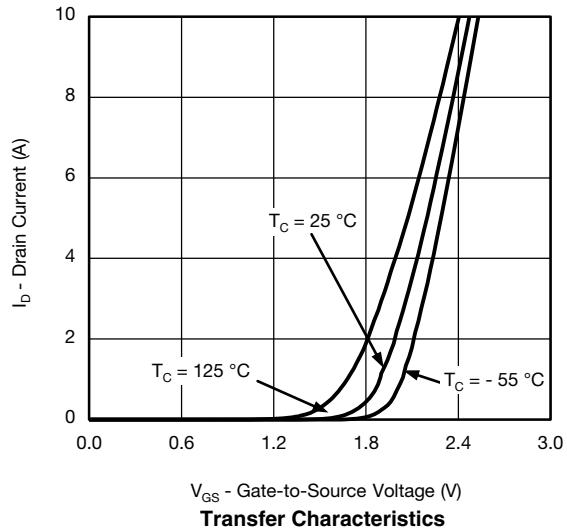
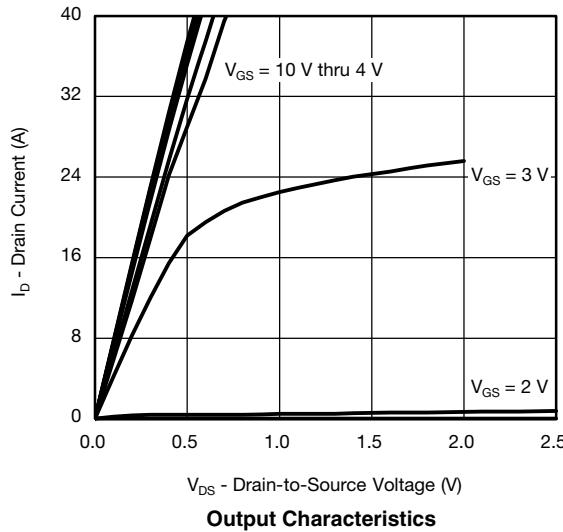
SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)								
Parameter	Symbol	Test Conditions			Min.	Typ. ^a	Max.	Unit
Dynamic^a								
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 15 \text{ V}$, $R_L = 3 \Omega$ $I_D \approx 5 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$ P-Channel $V_{DD} = -4 \text{ V}$, $R_L = 0.8 \Omega$ $I_D \approx -5 \text{ A}$, $V_{GEN} = -10 \text{ V}$, $R_g = 1 \Omega$	N-Ch		7	14	ns	
Rise Time	t_r		P-Ch		6	12		
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		11	22		
Fall Time	t_f		P-Ch		12	24		
Turn-On Delay Time	$t_{d(on)}$		N-Ch		15	30		
Rise Time	t_r		P-Ch		35	65		
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		8	16		
Fall Time	t_f		P-Ch		9	18		
Continuous Source-Drain Diode Current	I_S	$T_C = 25^\circ\text{C}$ N-Channel $V_{DD} = 15 \text{ V}$, $R_L = 3 \Omega$ $I_D \approx 5 \text{ A}$, $V_{GEN} = 4.5 \text{ V}$, $R_g = 1 \Omega$ P-Channel $V_{DD} = -4 \text{ V}$, $R_L = 0.8 \Omega$ $I_D \approx -5 \text{ A}$, $V_{GEN} = -4.5 \text{ V}$, $R_g = 1 \Omega$	N-Ch		16	30	A	
Pulse Diode Forward Current ^a	I_{SM}		P-Ch		22	40		
Body Diode Voltage	V_{SD}		N-Ch		55	100		
Body Diode Reverse Recovery Time	t_{rr}		P-Ch		18	35		
Body Diode Reverse Recovery Charge	Q_{rr}		N-Ch		22	40		
Reverse Recovery Fall Time	t_a		P-Ch		34	65		
Reverse Recovery Rise Time	t_b		N-Ch		10	20		
			P-Ch		14	28		
			N-Ch		49	98	ns	
			P-Ch		5.5	11		
			N-Ch		47	94		
			P-Ch		7.5			
			N-Ch		26		ns	
			P-Ch		6.5			
			N-Ch		23			

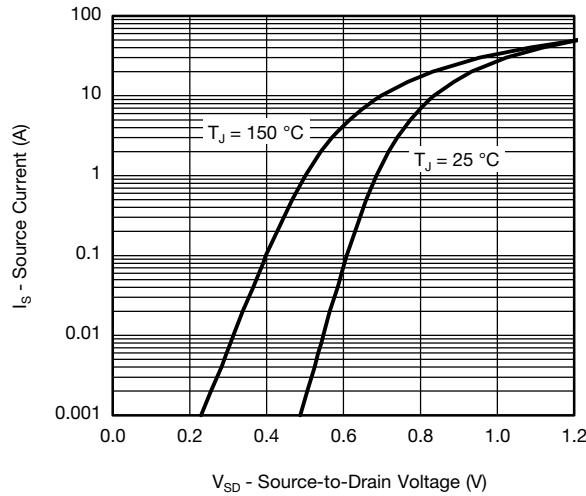
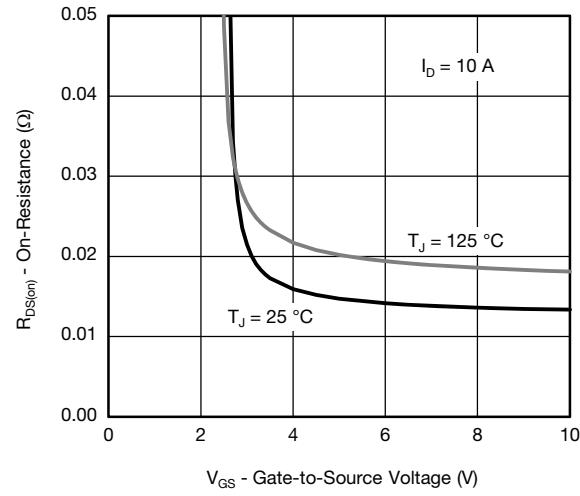
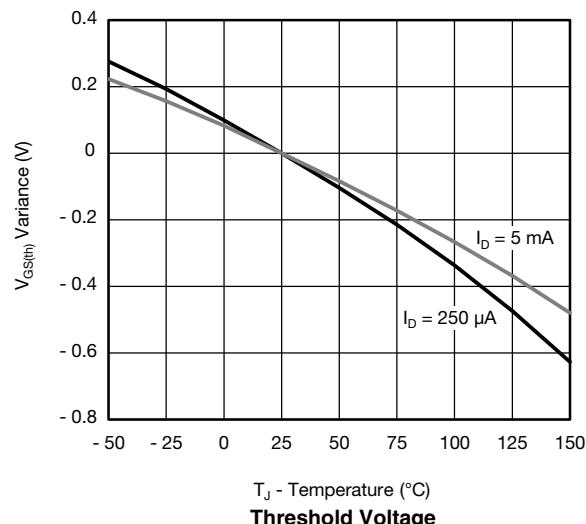
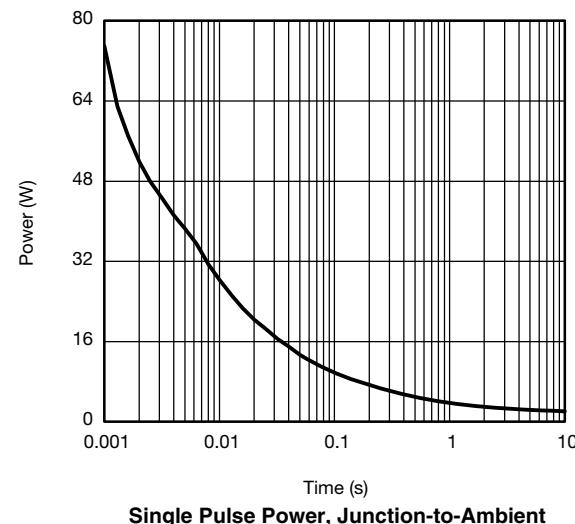
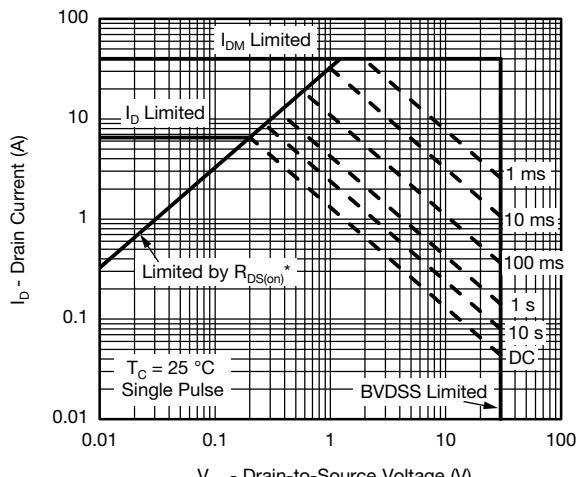
Notes:

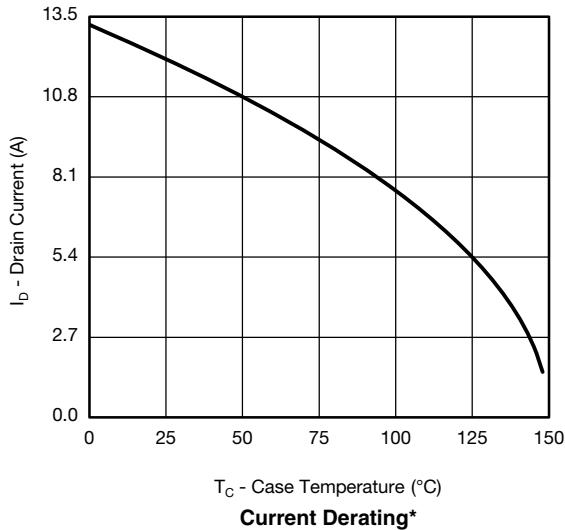
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

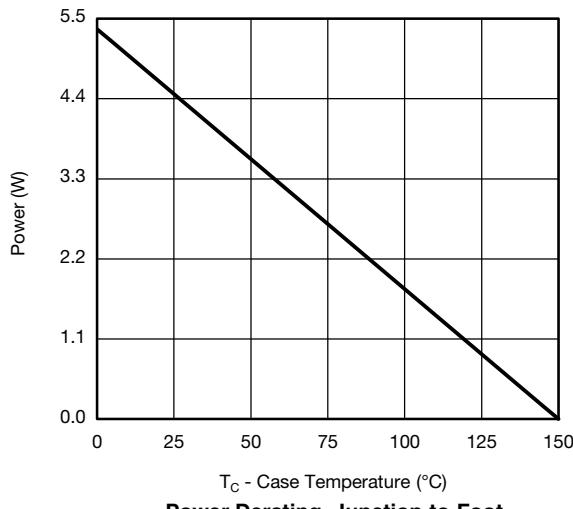
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

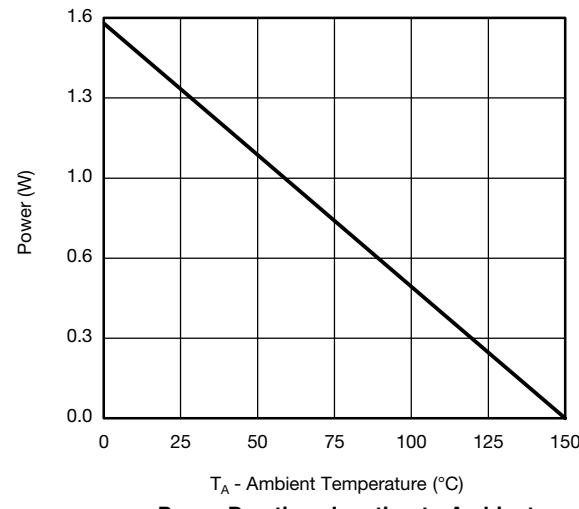
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Safe Operating Area, Junction-to-Ambient

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)T_c - Case Temperature (°C)

Current Derating*

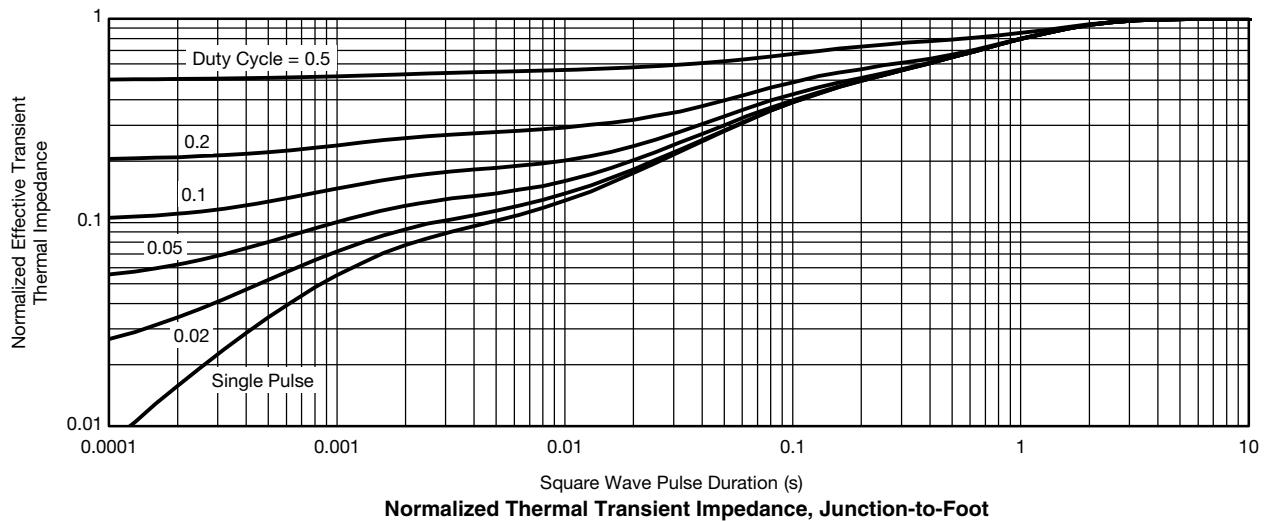
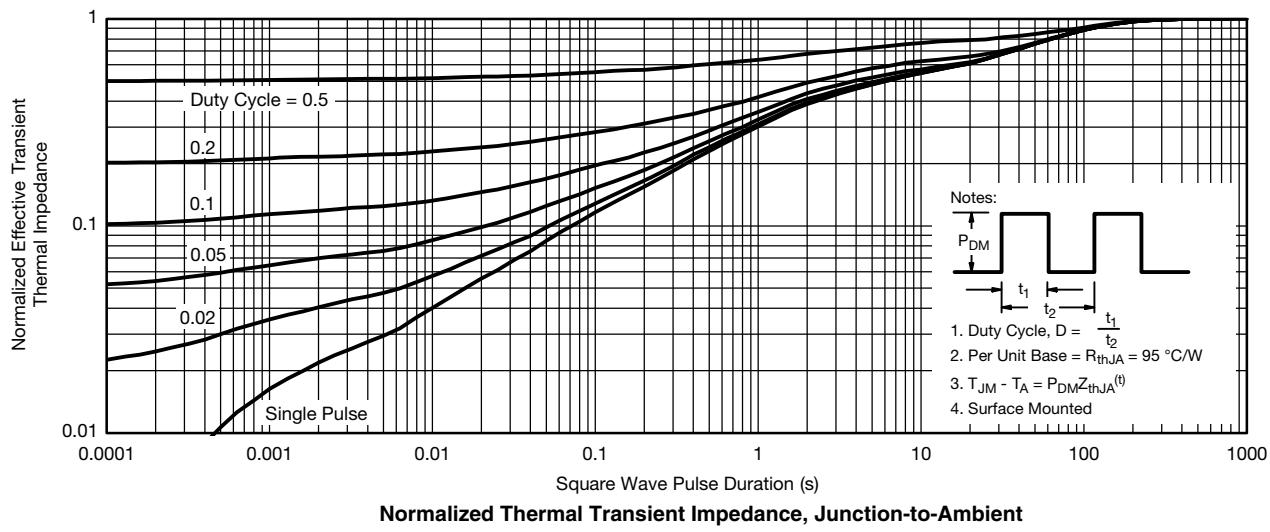
T_c - Case Temperature (°C)

Power Derating, Junction-to-Foot

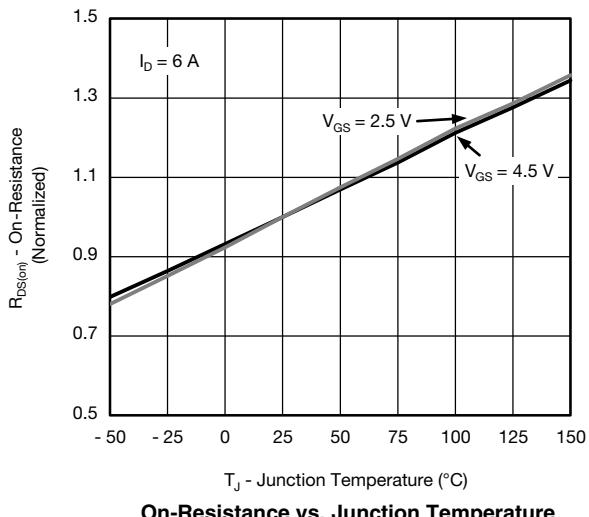
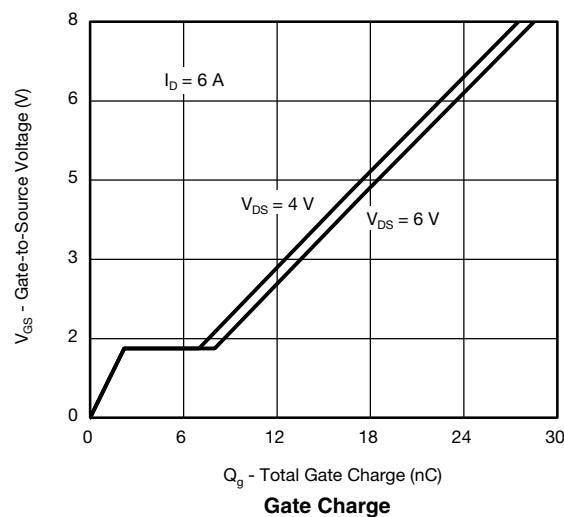
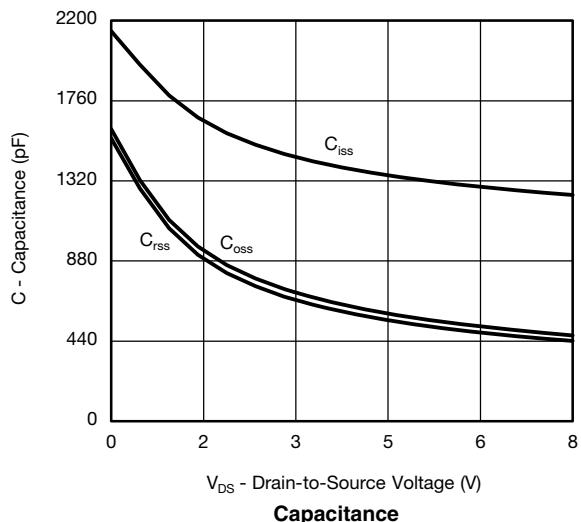
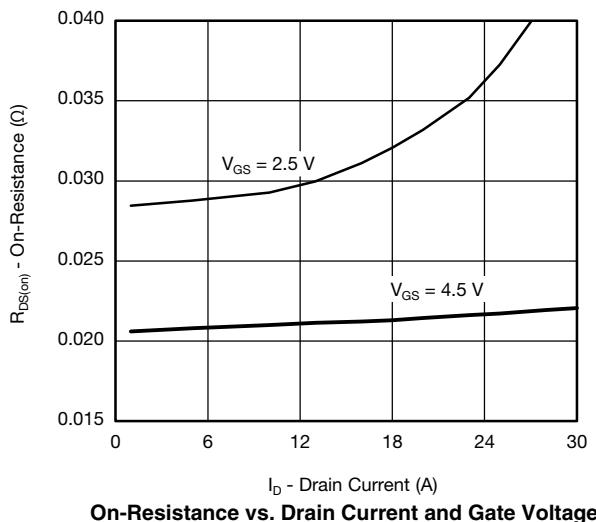
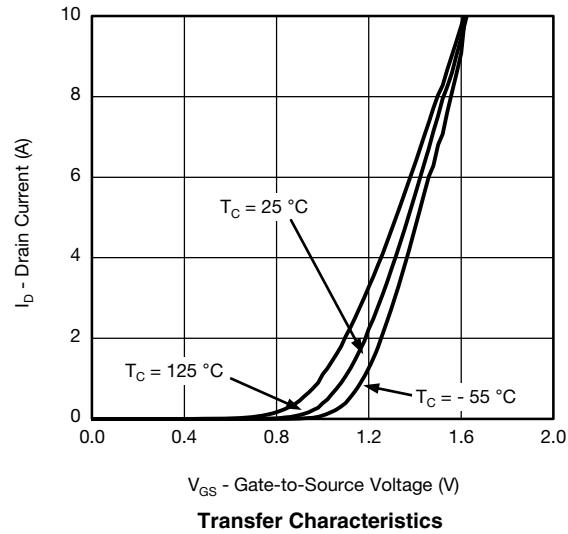
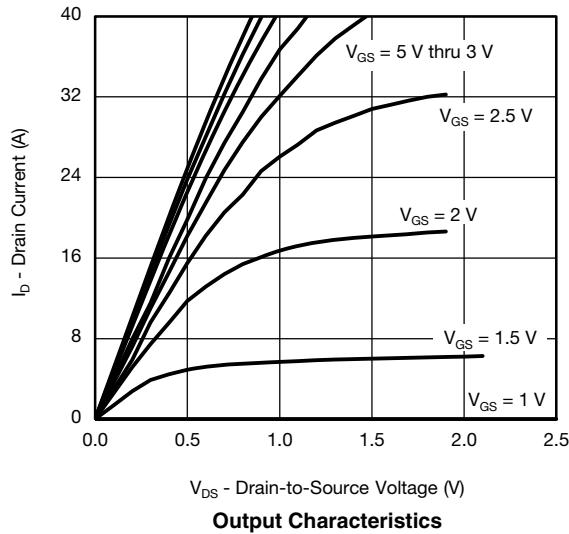
T_a - Ambient Temperature (°C)

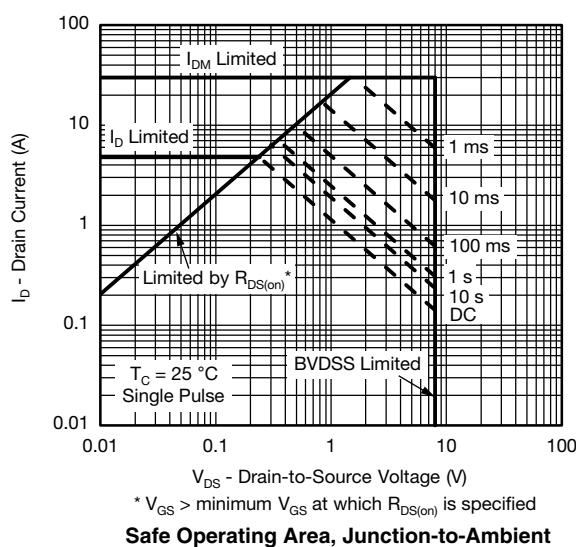
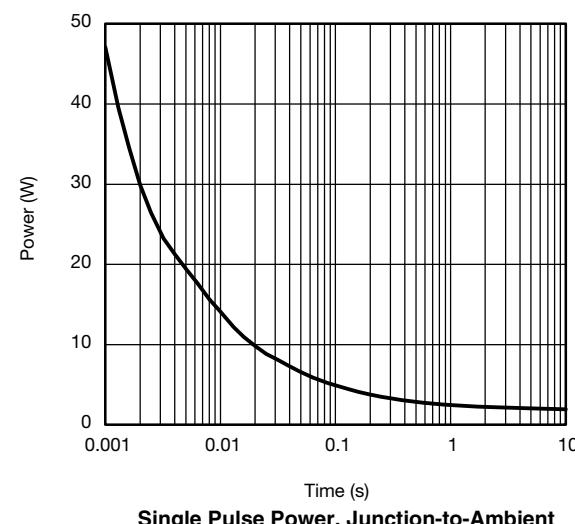
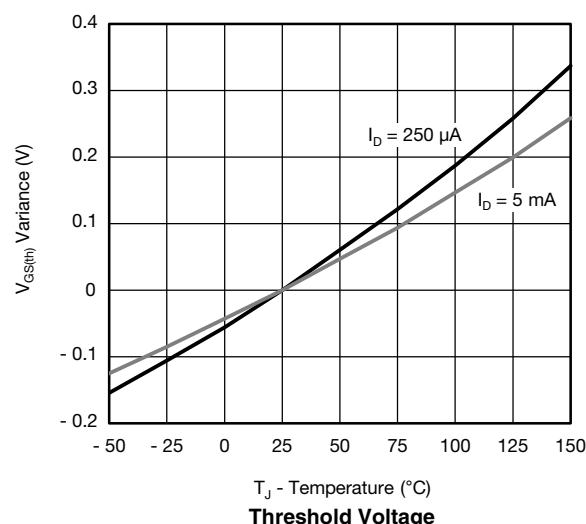
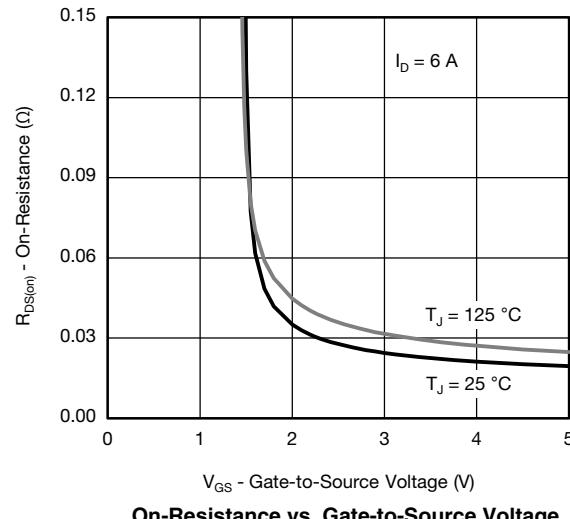
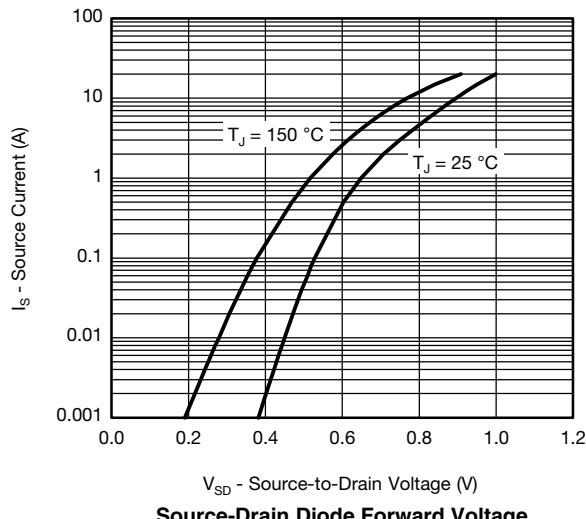
Power Derating, Junction-to-Ambient

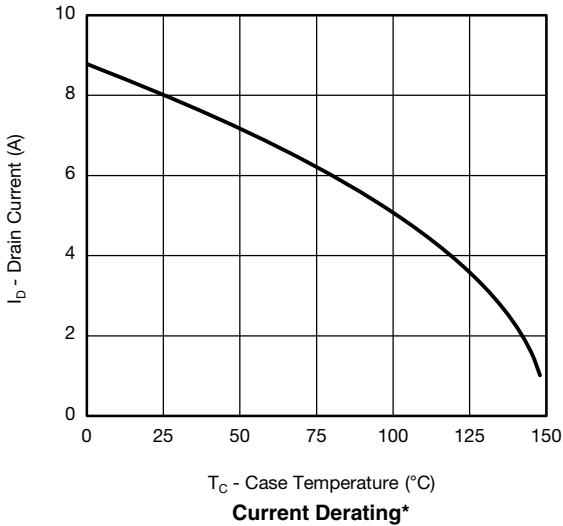
* The power dissipation P_D is based on T_{J(max)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


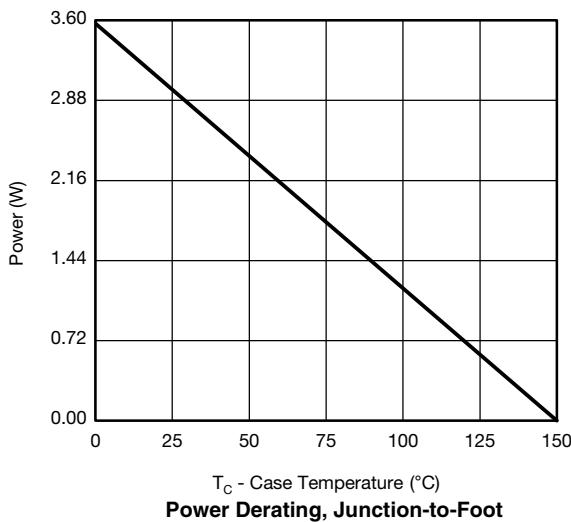
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



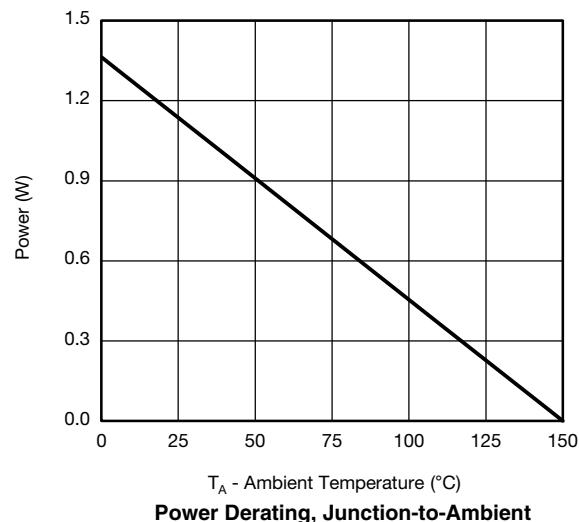
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted) T_C - Case Temperature (°C)

Current Derating*

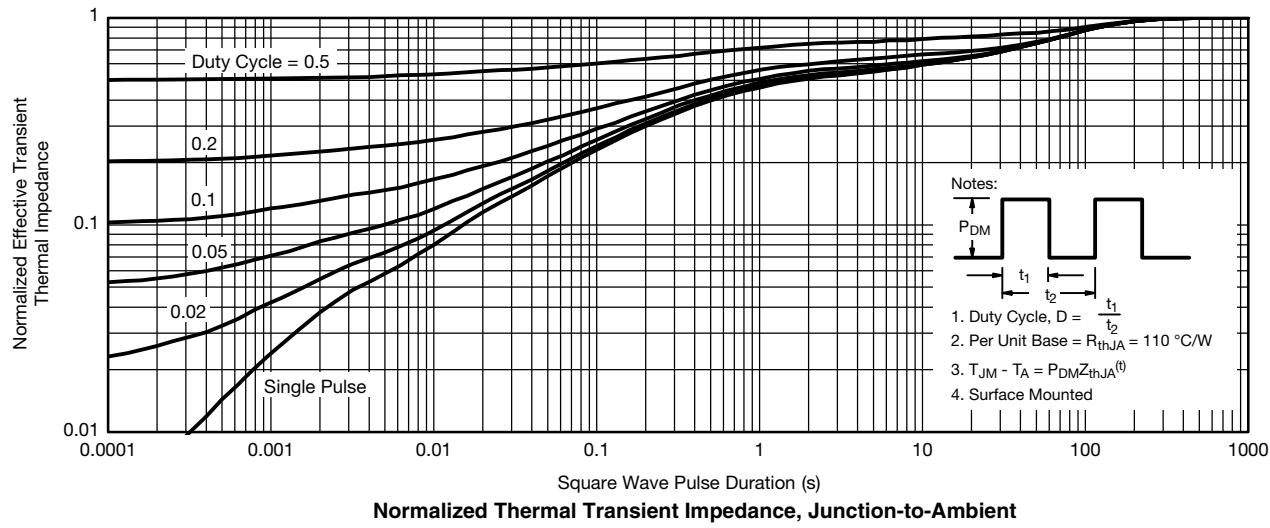
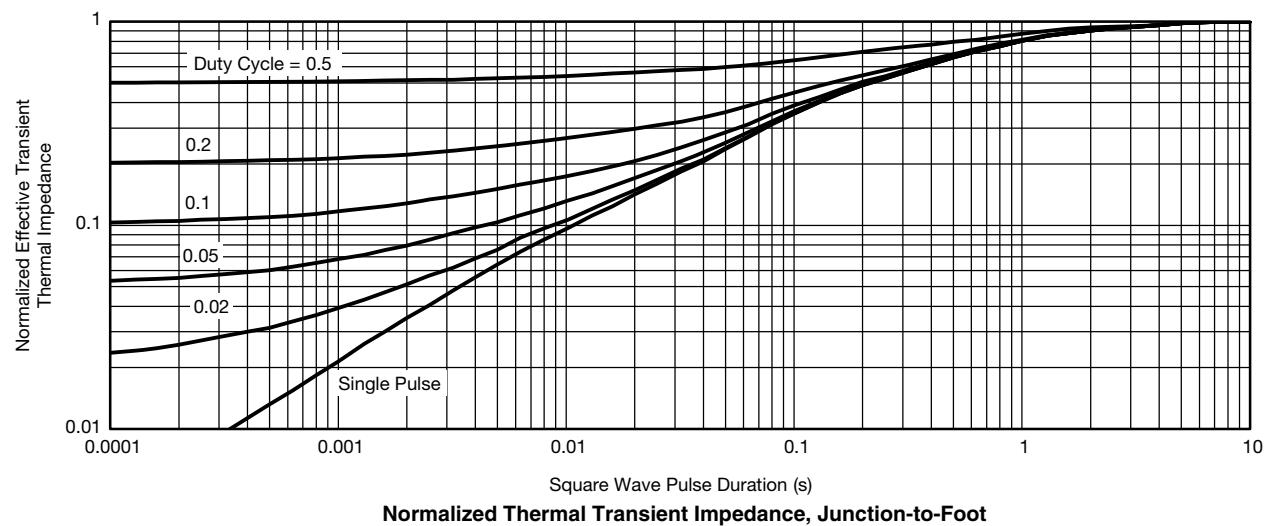
 T_C - Case Temperature (°C)

Power Derating, Junction-to-Foot

 T_A - Ambient Temperature (°C)

Power Derating, Junction-to-Ambient

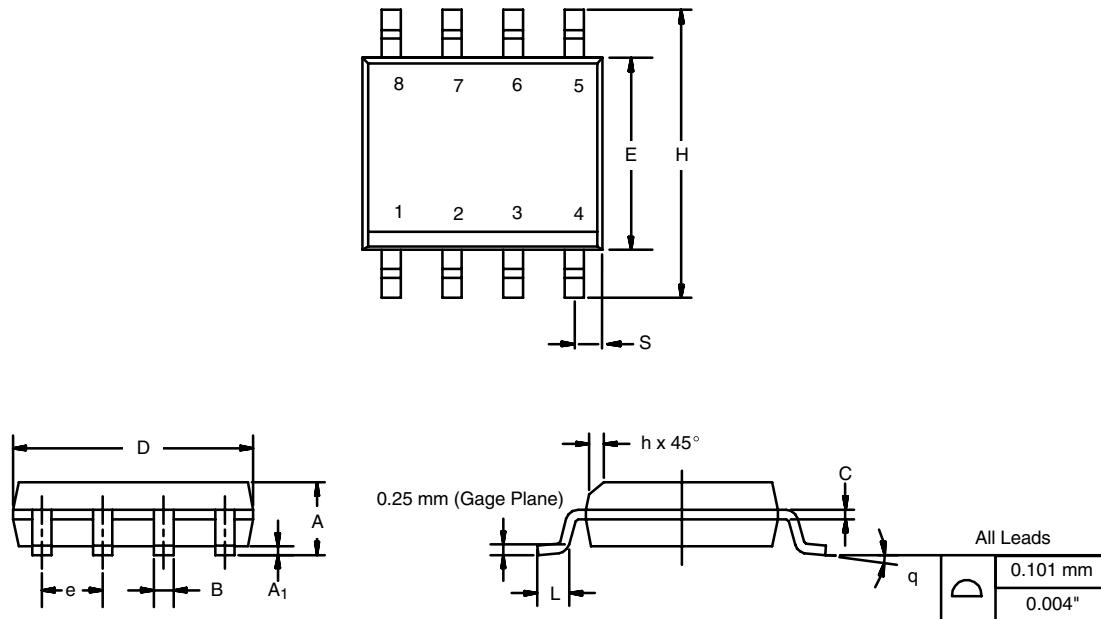
* The power dissipation P_D is based on $T_{J(\max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Foot

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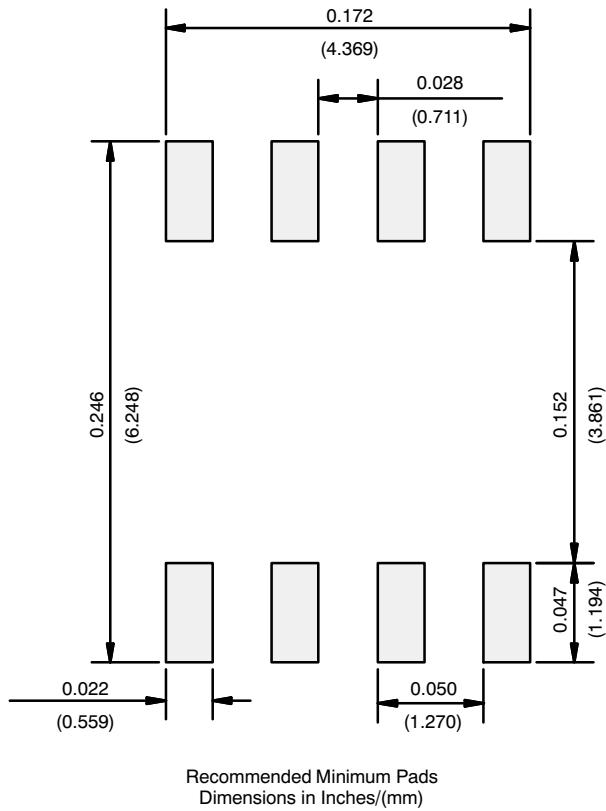
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06				
DWG: 5498				

RECOMMENDED MINIMUM PADS FOR SO-8



[Return to Index](#)



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[TPCC8103,L1Q\(CM](#) [MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#)
[IPS70R2K0CEAKMA1](#) [BUK954R8-60E](#) [DMN3404LQ-7](#) [NTE6400](#) [SQJ402EP-T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#)
[DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE2384](#)
[NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#) [NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE455](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#)
[NTE2911](#) [US6M2GTR](#) [TK10A80W,S4X\(S](#) [SSM6P69NU,LF](#)